

isc N-Channel MOSFET Transistor

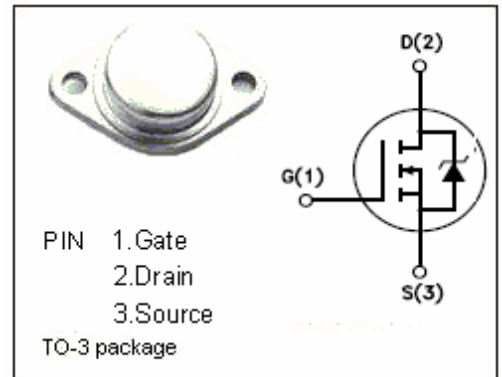
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DESCRIPTION

- silicon Gate for fast switching at elevate
- rugged

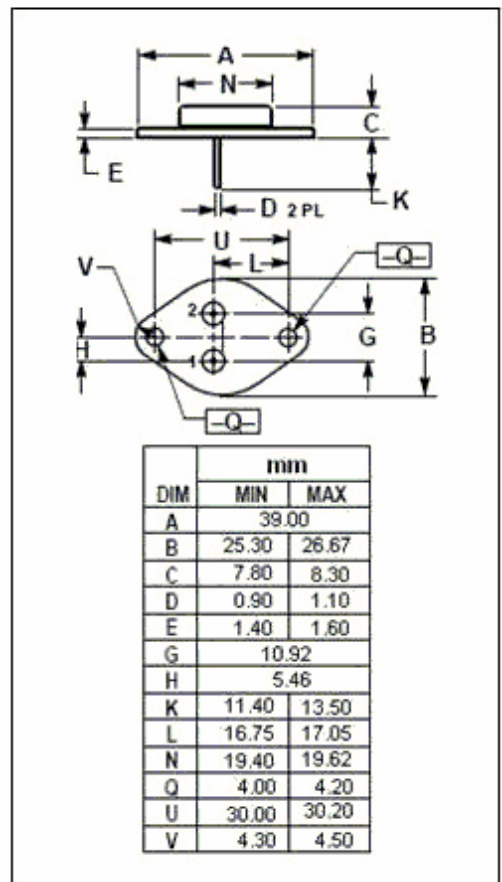
APPLICATIONS

- suited for applications such as
Switching power supplies, motor controls ,inverters,
Choppers, audio amplifiers and high energy pulse circuits.



ABSOLUTE MAXIMUM RATINGS(T_a=25°C)

SYMBOL	PARAMETER	VALUE	UNIT
V _{DSS}	Drain-Source Voltage (V _{GS} =0)	400	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current-continuous@ TC=25°C	22	A
P _{tot}	Total Dissipation@TC=25°C	300	W
T _j	Max. Operating Junction Temperature	-55~150	°C
T _{stg}	Storage Temperature Range	-55~150	°C



THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
R _{th j-c}	Thermal Resistance, Junction to Case	0.42	°C/W
R _{th j-a}	Thermal Resistance, Junction to Ambient	30	°C/W

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• ELECTRICAL CHARACTERISTICS ($T_C=25^{\circ}\text{C}$)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0$; $I_D=0.25\text{mA}$	400			V
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$; $I_D=250\mu\text{A}$	2		4	V
$R_{DS(ON)}$	Drain-Source On-stage Resistance	$V_{GS}=10\text{V}$; $I_D=14\text{A}$			0.25	Ω
I_{GSS}	Gate Source Leakage Current	$V_{GS}=\pm 20\text{V}$; $V_{DS}=0$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=400\text{V}$; $V_{GS}=0$			250	μA
V_{SD}	Diode Forward Voltage	$I_F=25\text{A}$; $V_{GS}=0$			1.8	V
C_{iss}	Input Capacitance	$V_{DS}=25\text{V}$; $V_{GS}=0\text{V}$; $f_T=1\text{MHz}$		4000		pF
C_{rss}	Reverse Transfer Capacitance			550		
C_{oss}	Output Capacitance			97		